

PUBLIC ANNOUNCEMENT
(Under Regulation 32 and 33 of the Insolvency and Bankruptcy
(Liquidation Process) Regulations, 2016)

1.	Name of Corporate Debtor	Lanco Infratech Limited
2.	Date of Incorporation Of Corporate Debtor	26/03/1993
3.	Authority Under Which Corporate Debtor Is Incorporated / Registered	Registrar of Companies Hyderabad
4.	Corporate Identity No./Limited Liability Identification No.of corporate debtor	L45200TG1993PLC015545
5.	Address of the Registered Office and Principal Office (if any) of Corporate Debtor	Registered Office: Lanco House, Plot No. 4, Software Units Layout, HITEC City, Madhapur, Hyderabad, Telangana, 500081, India. Principal Office: Plot 397, Phase - 3 Udyog Vihar, Gurugram 122016, Haryana, India.
6.	LIQUIDATION COMMENCEMENT DATE OF CORPORATE DEBTOR	27 August 2018
7.	NAME, ADDRESS, EMAIL ADDRESS, TELEPHONE NUMBER AND THE REGISTRATION NUMBER OF THE LIQUIDATOR	Name: Savan Godiawala Address: Deloitte Touche Tohmatsu India LLP 19 th Floor, Shapath – V, S.G. Road, Ahmedabad -380015 Email Address (registered with IBB): sgodiawala@deloitte.com Telephone Number: +91 (79) 66827341 Insolvency Professional Regn. No.: IBBI/IPA-001/IP-P00239/2017-18/10468 Correspondence Address : Deloitte Touche Tohmatsu India LLP 22 nd Floor, Building No. 5, Tower A, DLF Cyber City Phase III, Gurugram - 122002, Haryana, India Correspondence email address: inlancoinfratechip@deloitte.com
8.	DATE OF E-AUCTION	Auction StartDate 17 May, 2019 Auction EndDate 23 May, 2019
9.	MANNER OF OBTAINING THE PROCESS DOCUMENT	The detailed terms and conditions of the auction process are set out in the Process Document, which can be obtained by the bidders by sending an email request at inlancoinfratechip@deloitte.com .
10.	LAST DATE OF OBTAINING THE PROCESS DOCUMENT	9 May, 2019
11.	SUBJECT MATTER OF AUCTION PROCESS	(a)Acquisition of the Corporate Debtor's business(es) as a going concern; (b)Acquisition of the shares held by the Corporate Debtor in various entities; (c)Acquisition of the immovable fixed assets of the Corporate Debtor; (d)Acquisition of the other tangible assets of the Corporate Debtor, including plant, machinery, equipment, furniture, inventory, stores & spares, art and artefacts, vehicles, etc., whether on an individual basis or as a block of assets. Paragraph number (b) to (e) are hereinafter collectively referred to as " Assets ".
12.	MANNER OF SUBMITTING BID	As set out in the process document to be issued by the liquidator of the Corporate Debtor.
13.	MODE OF SALE	The mode of sale is open e-auction where bidders can view other competitive bids from other bidders during the open window. Separate auction process shall be carried out for acquisition of the Corporate Debtor as a going concern and for different Asset categories. Preference shall be given to the Bidders submitting Bid for the Corporate Debtor as a going concern and maximizing the value for the Corporate Debtor/stakeholders. The sale shall be on an 'as is where is' basis without any representation, warranty or indemnity by the Corporate Debtor or the liquidator.

Note: Nothing contained herein shall constitute a binding offer or a commitment to sell the Corporate Debtor as a going concern or any of its Assets.

Bidders must note that the aforementioned auction process is being conducted in accordance with the Insolvency and Bankruptcy Code, 2016 ("Code") and the relevant regulations thereunder. Any assets realised by existing charge holders in pursuance of Section 52 of the Code shall be excluded from the ambit of the auction process being conducted by the liquidator, as and when such an option is exercised by the relevant charge holder.

The liquidator reserves the right, without giving reasons, at any time and in any respect, to amend and/or annul this invitation. Any amendment in the aforementioned timelines will be notified on the website of the Corporate Debtor <http://www.lancogroup.com/DynTestform.aspx?pageid=127>.

Sd/-
Savan Godiawala
Insolvency Professional Regn. No.: IBBI/IPA-001/IP-P00239/2017-18/10468
Email-id: inlancoinfratechip@deloitte.com
Date: 18th April 2019
Place: Ahmedabad